

R R R R

В

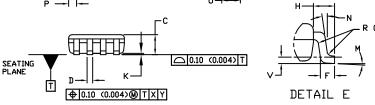


DATE 01 SEP 2021

NOTES:

DETAIL E

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURR. MOLD FLASH, PROTRUSION, OR GATE BURR SHALL NOT EXCEED 0.14 (0.0055") PER SIDE.
- DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH AND PROTRUSION SHALL NOT EXCEED 0.14 (0.0055") PER SIDE.
- 5. LEAD FINISH IS SOLDER PLATING WITH THICKNESS OF 0.0076-0.0203 MM (0.003-0.008").
- ALL TOLERANCE UNLESS OTHERWISE SPECIFIED ±0.0508 MM (0.002").

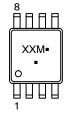


H N R 0.10 TYP
v-1 - F - /
DETAIL E

8x 0.30
1 0.50 PITCH PECCHMENDED *
RECOMMENDED * MOUNTING FOOTPRINT

	MILLIM	ETERS	INCHES		
DIM	MIN.	MAX.	MIN.	MAX.	
Α	1.90	2.10	0.075	0.083	
В	2.20	2.40	0.087	0.094	
С	0.60	0.90	0.024	0.035	
D	0.17	0.25	0.007	0.010	
F	0.20	0.35	0.008	0.014	
G	0.50 BSC		0.020 BSC		
H	0.40 REF		0.016 REF		
J	0.10	0.18	0.004	0.007	
К	0.00	0.10	0.000	0.004	
L	3.00	3.25	0.118	0.128	
М	0*	6*	0*	6*	
N	0*	10*	0*	10*	
Р	0.23	0.34	0.010	0.013	
R	0.23	0.33	0.009	0.013	
2	0.37	0.47	0.015	0.019	
U	0.60	0.80	0.024	0.031	
V	0.12 BSC		0.005 BSC		
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GENERIC MARKING DIAGRAM*



XX = Specific Device Code

Μ = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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